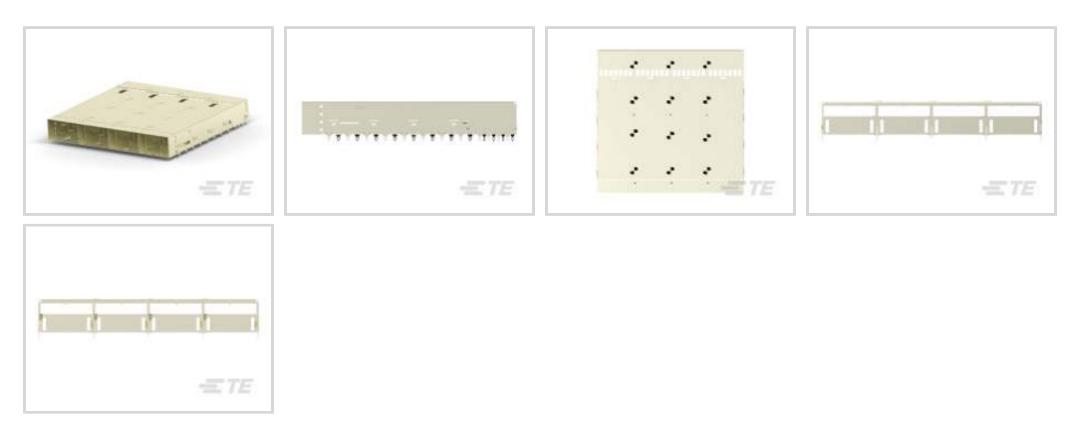
2315853-4 - ACTIVE

TE Internal #: 2315853-4 OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-Fit Mount, Printed Circuit Board, Board Mount, -67 – 185 °F [-55 – 85 °C]

View on TE.com >

Connectors > Pluggable IO Connectors & Cages > OSFP



Pluggable I/O Product Type: Cage Assembly

Connector System: Cable-to-Board

Port Matrix Configuration: 1 x 4

PCB Mounting Style: Through Hole - Press-Fit

Sealable: No

Features

Product Type Features



Form Factor	OSFP						
Cage Туре	Ganged						
Pluggable I/O Product Type	Cage Assembly						
Connector System	Cable-to-Board						
Sealable	No						
Connector & Contact Terminates To	Printed Circuit Board						
Configuration Features							
Port Matrix Configuration	1 x 4						
Mechanical Attachment							
PCB Mounting Style	Through Hole - Press-Fit						
Connector Mounting Type	Board Mount						
Usage Conditions							
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]						
Operation/Application							

2315853-4

OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-Fit Mount, Printed Circuit Board, Board Mount, -67 – 185 °F [-55 – 85 °C]



Circuit Application	Signal							
Packaging Features								
Packaging Method	Tray							
Other								
Included Lightpipe	No							

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant					
EU ELV Directive 2000/53/EC	Compliant					
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold					
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC					
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free					
Solder Process Capability	Not applicable for solder process capability					

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

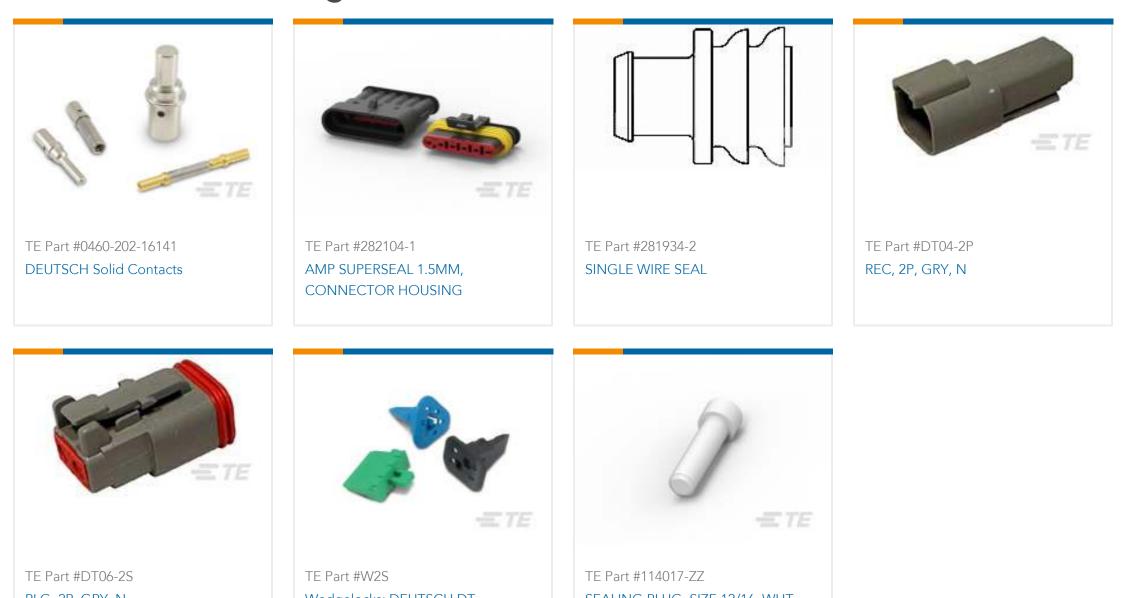
2315853-4

OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-Fit Mount, Printed Circuit Board, Board Mount, -67 – 185 °F [-55 – 85 °C]





Customers Also Bought



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Documents

Product Drawings

CAGE ASSEMBLY, 1X4, NO EMI SPRINGS, OSFP

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2315853-4_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2315853-4_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2315853-4_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

2315853-4

OSFP, Cage Assembly, Cable-to-Board, 1 x 4, Through Hole - Press-Fit Mount, Printed Circuit Board, Board Mount, -67 – 185 °F [-55 – 85 °C]



Datasheets & Catalog Pages

OSFP Cages, Connectors, and Cable Assemblies (English)

English

Product Specifications

Application Specification

English

Product Environmental Compliance Product Compliance

English

Product Compliance

English